# **Explorer in Surface Engineering**

# Financial Results Briefing Material

for the Third Quarter of the Fiscal Year Ending March 2022

#### **JCU CORPORATION**

TSE First Section (Stock Code: 4975)



February 4, 2022

# **Summary of Consolidated Financial Results for 3Q FY3/22**

#### **Overview of Financial Results**

Accounting Period of 3Q FY3/22

JCU (non-consolidated): April 1 to December 31

Overseas subsidiaries: January 1 to September 30

#### For electronic components

- In China: Increase in demand for PWBs for high-performance electronic devices such as tablets and for servers Demand for chemicals increased significantly due to operations of newly acquired production lines being fully in progress
- In Taiwan: Increase in demand for semiconductor package substrates for high-performance electronic devices and servers
  - Demand for chemicals increased due to the acquisition of new production lines
- In South Korea: Demand for semiconductor package substrate increased due to strong demand for semiconductors. Demand for chemicals increased due to the acquisition of new production lines

#### For automotive components

- In Japan, although the recovery trend in the automotive industry is slowing down due to a shortage of semiconductors and other materials, demand for chemicals increased as the industry remained strong until the first half of the fiscal year.
- Overseas, although the recovery trend in the automotive industry is slowing down due to a shortage of semiconductors and other materials in China, demand for chemicals increased significantly as the industry remained strong until the first half of the fiscal year.

#### **Machine Business**

■ Net sales decreased substantially due to the continued cautious attitude toward new investment, although there were signs of recovery in capital investment for automotive components, represented by the resumption of postponed projects.



# **Summary of Consolidated Financial Results for 3Q FY3/22**

(Millions of yen)

	Same period of previous FY (3Q FY3/21)	3Q FY3/22	YoY % Change
Net sales	15,424	17,841	15.7%
Operating profit	4,951	6,626	33.8%
Ordinary profit	4,992	6,743	35.1%
Profit attributable to owners of parent	3,403	4,620	35.8%
Net income per share	128.66 yen	176.47 yen	-

# **Progress Rate against FY3/22 Forecasts**

(Millions of yen)

	3Q FY3/22	FY3/22 Forecasts (Revised on Nov. 4, 2021)	Progress rate against full- year forecast
Net sales	17,841	23,500	75.9%
Operating profit	6,626	8,300	79.8%
Ordinary profit	6,743	8,350	80.8%
Profit attributable to owners of parent	4,620	5,900	78.3%
Net income per share	176.47 yen	225.19 yen	-

#### **Foreign Exchange Rates**

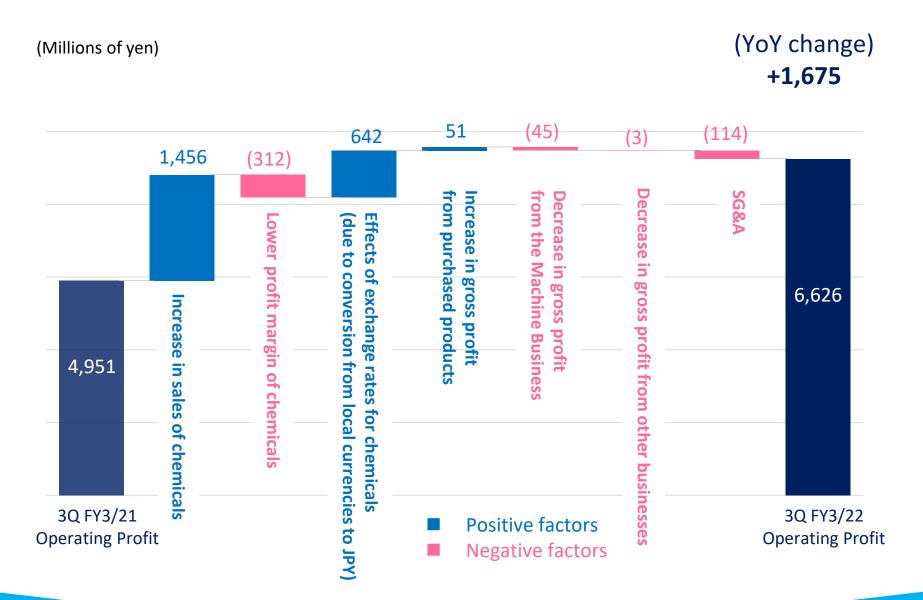
(Yen)

	FY3/21			FY3/22				
	1Q	2Q	3Q	4Q	(Initial forecast)	1Q	2Q	3Q
Chinese yuan (CNY)	15.61	15.39	15.38	15.48	15.50	16.36	16.66	16.78
Taiwan dollar (TWD)	3.62	3.61	3.62	3.63	3.60	3.77	3.84	3.88
Korean won (KRW)	0.0914	0.0898	0.0897	0.0906	0.0900	0.0951	0.0964	0.0959

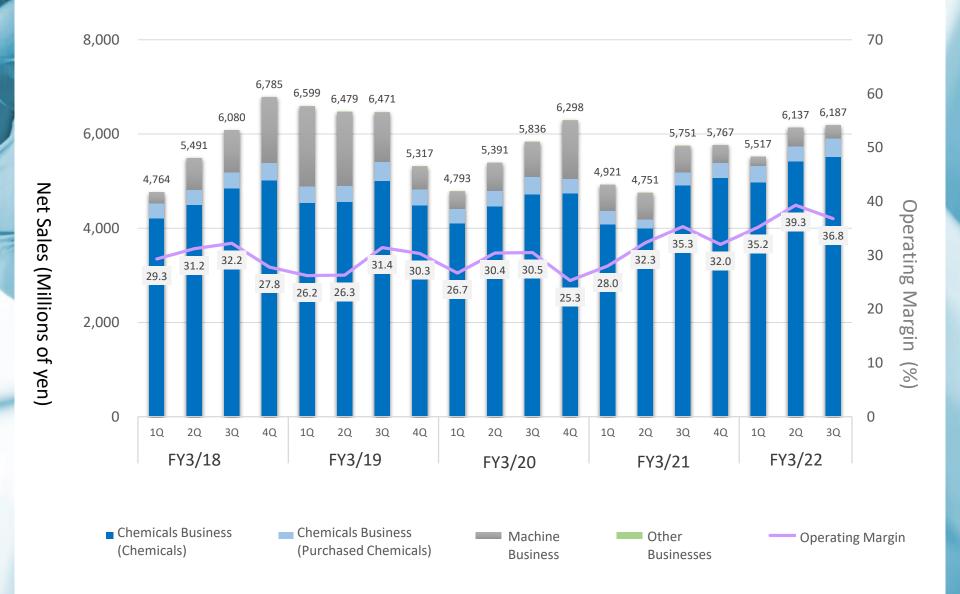
Note: The average rate for the period is used to translate Chinese yuan, Taiwan dollar and Korean won, our major foreign currencies, to Japanese yen.

Foreign exchange sensitivity (as at the consolidated year): Changes of about 90 million yen in consolidated operating profit with 1 % change in major currency rates listed above

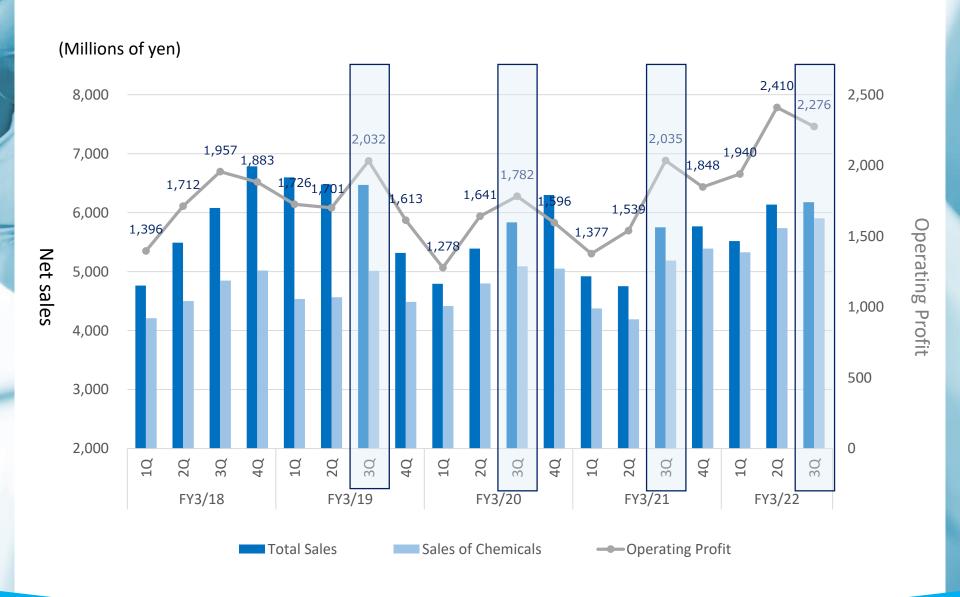
## **Changes in Consolidated Operating Profit for 3Q FY3/22**



### **Quarterly Consolidated Financial Results (By Segment)**

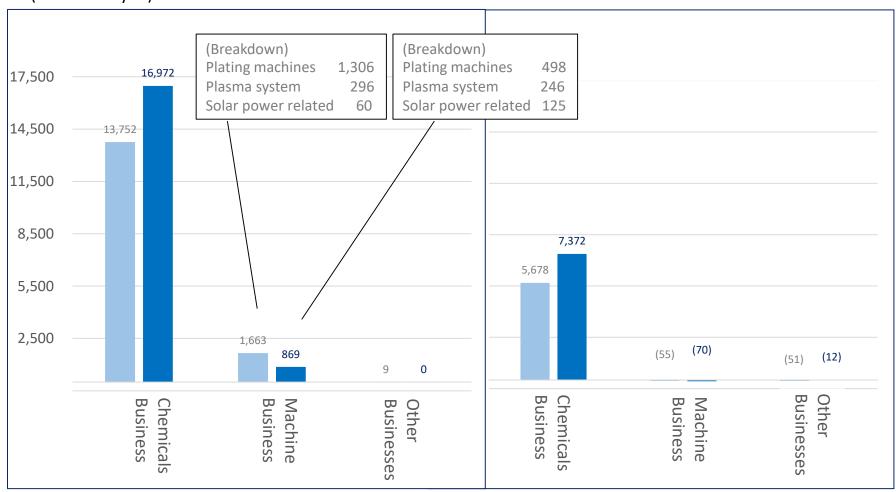


#### **Quarterly Consolidated Financial Results**



### **Consolidated Segment Results for 3Q FY3/22**

#### (Millions of yen)



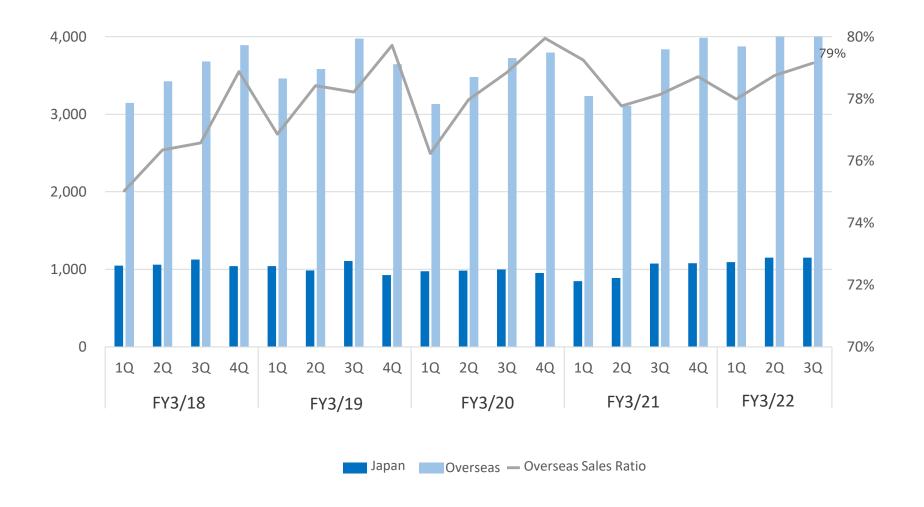
**Net Sales** 

Segment Profit (Loss)

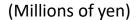


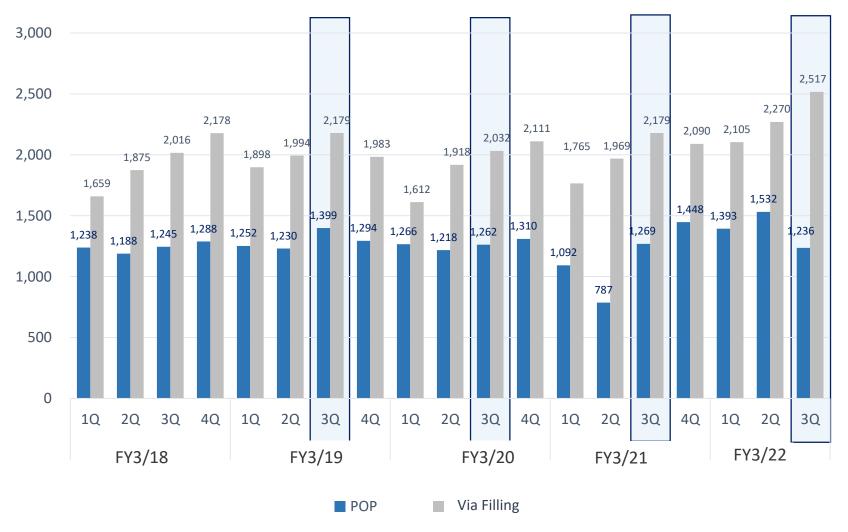
### **Quarterly Sales of Chemicals in Japan and Overseas**

(Millions of yen)

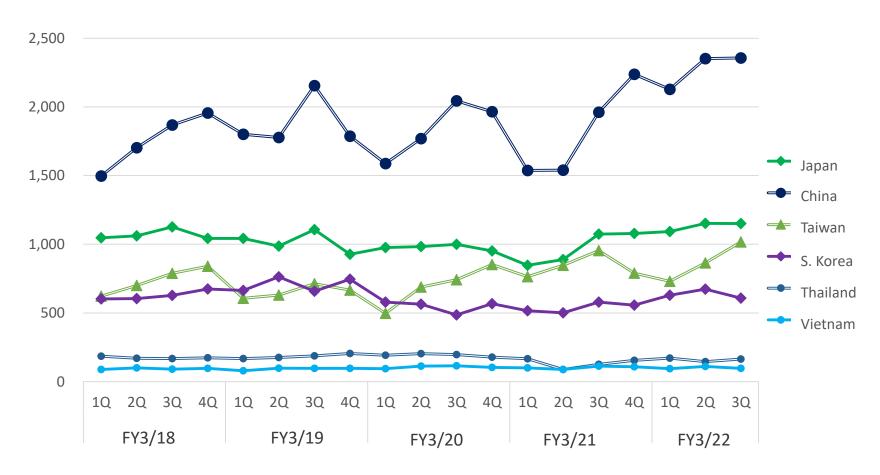


### **Quarterly Sales of Chemicals for POP and Via Filling**



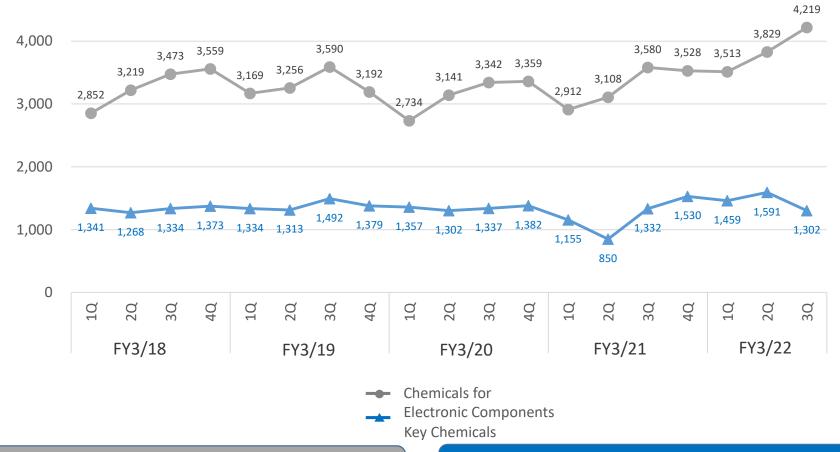


#### (Millions of yen)



(Millions of yen)

#### Consolidated

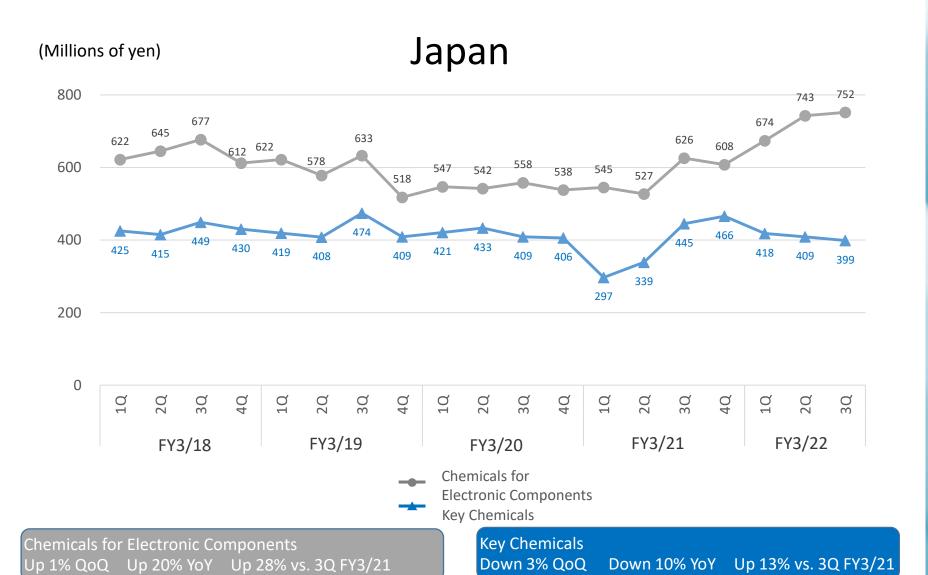


Chemicals for Electronic Components
Up 10% QoQ Up 18% YoY Up 20% vs. 3Q FY3/21

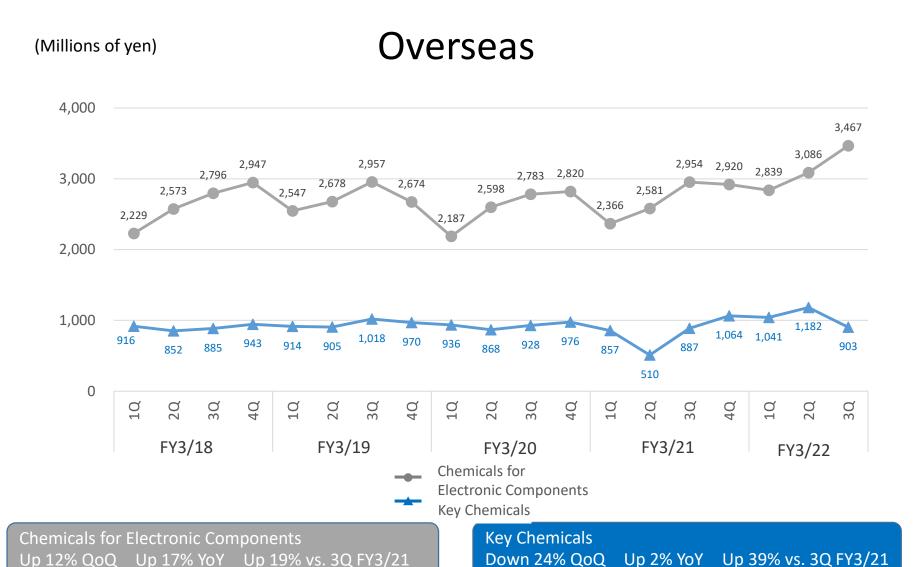
Key Chemicals
Down 18% QoQ

Down 2% YoY Up 30% vs. 3Q FY3/21

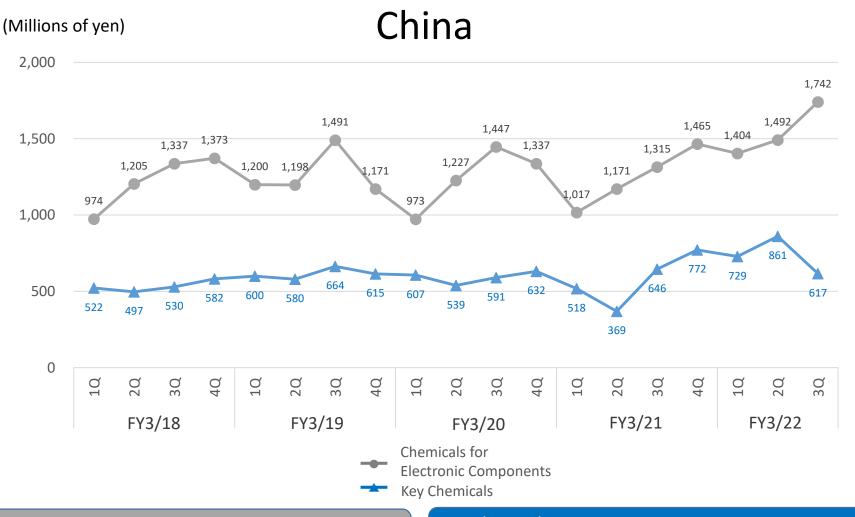








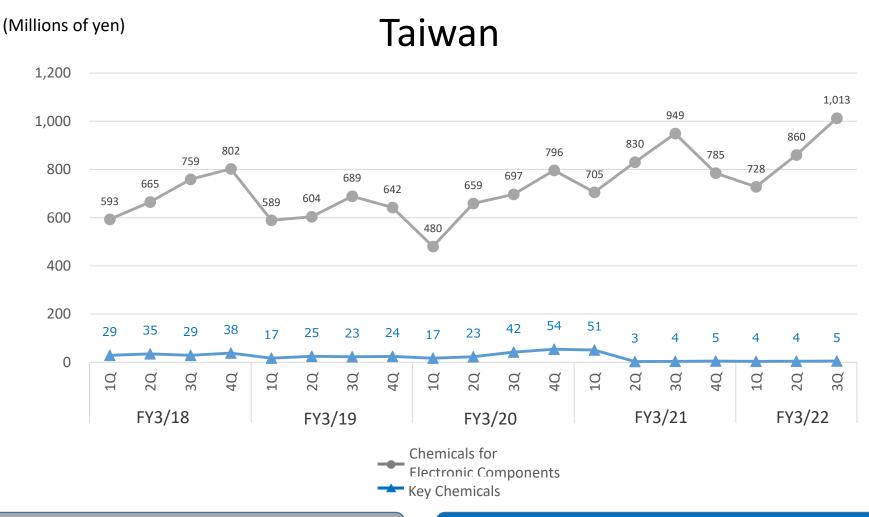




Chemicals for Electronic Components
Up 17% QoQ Up 32% YoY Up 32% vs. 3Q FY3/21

Key Chemicals
Down 28% QoQ Down 5% YoY Up 44% vs. 3Q FY3/21

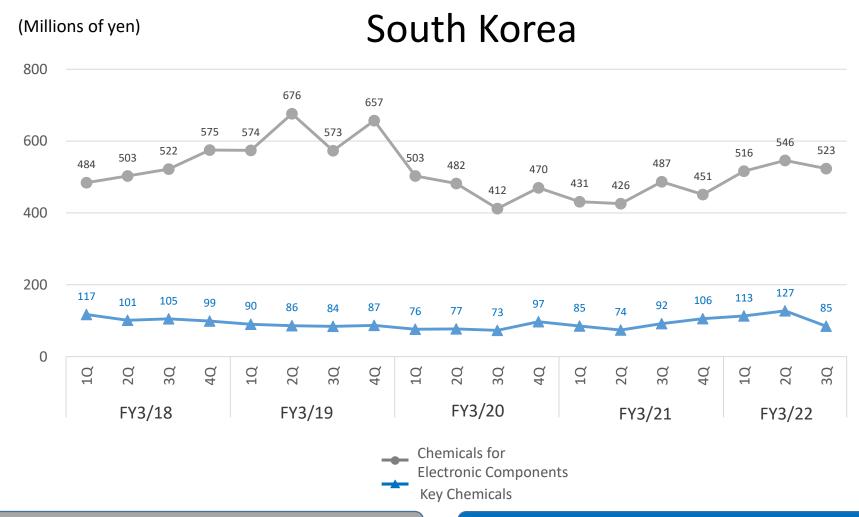




Chemicals for Electronic Components
Up 18% QoQ Up 7% YoY Up 5% vs. 3Q FY3/21

Key Chemicals
Up 26% QoQ Up 9% YoY Down 78% vs. 3Q FY3/21





Chemicals for Electronic Components

Down 4% QoQ Up 7% YoY Up 18% vs. 3Q FY3/21

Key Chemicals

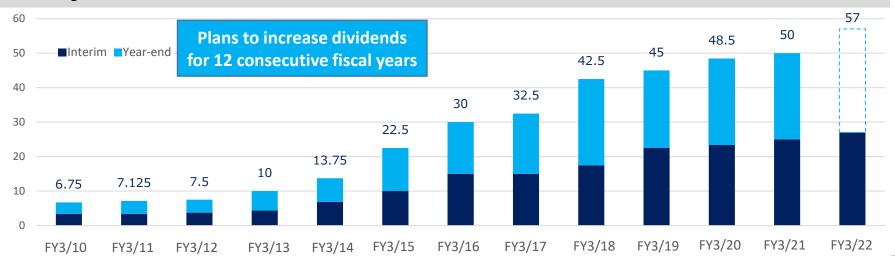
Down 33% QoQ Down 8% YoY Up 29% vs. 3Q FY3/21



#### **Dividend Forecast (Upward Revision)**

		FY3/20	FY3/21	FY3/22 (Initial forecasts)	FY3/22 (Revised forecasts)
Divid s	Interim	23.5 yen	25.0 yen	27.0 yen	27.0 yen
dends share	Year- end	25.0 yen	25.0 yen	27.0 yen	<b>30.0</b> yen
per	Annual	48.5 yen	50.0 yen	54.0 yen	7 57.0 yen

We will continue to make investments for sustainable growth while securing liquidity on hand and maintaining stable financial base. Our basic dividend policy is to return profits to shareholders through the flexible acquisition of treasury stock, with the aim of continuing the trend of stable dividend increases.





# Reference

- Company Profile
- Major Distribution Channels
- Major Products
- Usages of Chemicals and Typical Final Products

#### **Company Profile**

**ISO Certificates** 

Founded in : December 1957

**Established on** : April 1, 1968

Capital stock : 1,245 million yen

Annual sales Non-consolidated: 11.6 billion yen / Consolidated: 22.0 billion yen

(For the fiscal year ended March 31, 2021)

**Head office**: TIXTOWER UENO 16F, 8-1 Higashiueno 4-chome, Taito-ku, Tokyo

**Lines of** Manufacturing and sale of surface treatment chemicals, surface

**business** treatment machines, and related materials

Representative : Masashi Kimura, Chairman and CEO

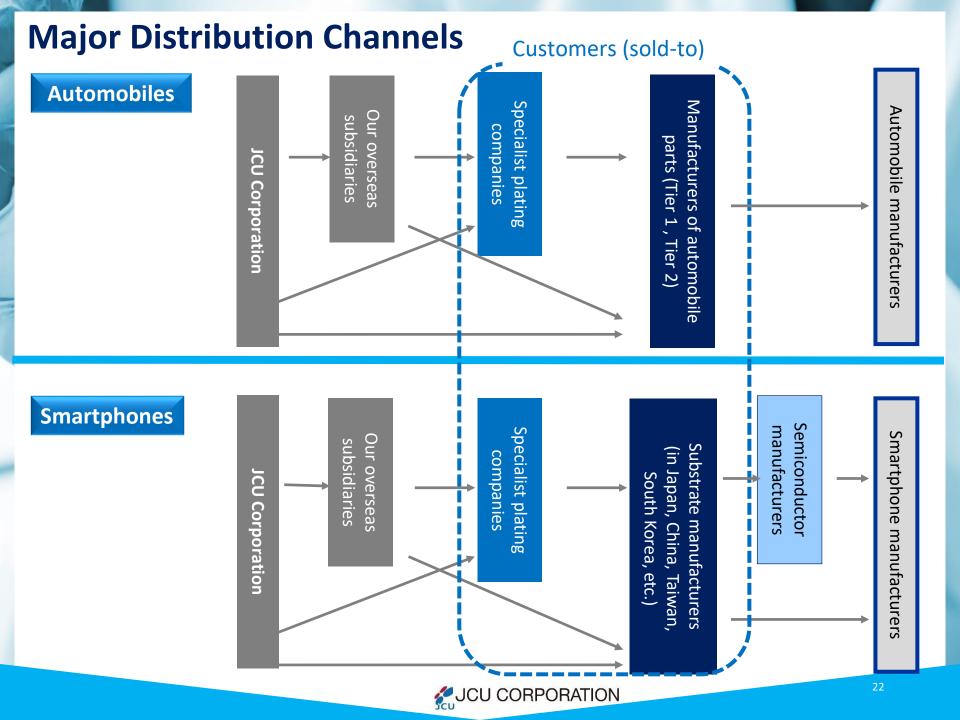
Employees : Non-consolidated: 250 / Consolidated: 561

(As of March 31, 2021)

ISO9001 Production Headquarters, Head Office Sales and Marketing Department,

and R&D Center (JCQA-0281)

ISO14001 Production Headquarters and R&D Center (JCQA-E-0143)



# **Major Products**

Chemicals	For decoration and rust-proofing (Key chemicals)	Automotive parts (front grilles, door handles, emblems, etc.) Faucet parts (water supply equipment, showerheads, drain plugs, etc.) Construction materials (bolts, nuts, etc.)
Business	For electronic components (Chemicals for electronic components)	PWBs (reversible and multilayer substrates, build-up boards, package substrates, etc.) Electronic components (lead frames, chip components, connectors, etc.) Semiconductors (silicon wafers)

	Fully-automated surface treatment equipment	Fully-automated equipment from input of materials to completion of the plating process
na di	Peripheral equipment	Manufacturing and sale of filtration machines and other peripheral equipment to be attached to surface treatment equipment
Machine Business	Automatic analytical control systems	Automatic management of plating solutions by analyzing concentrations of chemicals and adding chemicals when an insufficient level is detected
	Plasma system	Etching and washing devices for PWBs as part of pre-plating processes
	Solar power generation equipment	Installation and operation of solar power generation equipment (photovoltaic panels)



# **Usages of Chemicals and Typical Final Products**

Des	Final products	
Key chemicals	Surface treatment (plating) chemicals for decorative and rust- proofing purposes such as those for providing a metal appearance and preventing rust.	Automotive parts, faucet parts and construction materials
POP (Plating on Plastics) chemicals	Major products for key chemicals Chemicals for metal coating on plastics	(Automotive parts) Front grilles, emblems, etc. (Faucet parts) Showerheads, water faucet cocks, etc.
Other key chemicals	Chemicals for metal coating on metallic materials such as copper and steel	(Construction materials) Screws, hinges, etc.
Chemicals for electronic components	Plating chemicals for manufacturing PWBs, such as a circuit for electronic signals and an electrical contact for electronic components	5G-related components, data centers and other infrastructures and high-performance electronic devices
Via filling chemicals (for PWBs/motherboards)	Copper plating chemicals for formulating interconnection onto PWBs/motherboards embedded in electronic products	(5G-related components) 5G base stations, in-vehicle PWBs, smart
Via filling chemicals (for semiconductor package boards)	Copper plating chemicals for formulating interconnection onto PWBs (semiconductor packages boards) for the purpose of protecting a semiconductor chip from the external environment and mounting to PWBs	home appliances, etc.  (Data centers and other infrastructures)  Motherboards for communication servers etc.  (High-performance electronic devices)
Other	Plating chemicals for connecters and lead frames, etching chemicals for scraping unnecessary copper when formulating interconnection onto motherboards or semiconductor packages boards	Smartphones, PCs, tablets, game consoles, etc.



This material contains current plans and forecasts of future performance of JCU CORPORATION. These plans and forecast figures are prepared by the Company based on currently available information. This material does not give any assurance or guarantee of the Company's future financial performance and actual results may differ substantially from these plans for a number of conditions or developments in the future.

JCU CORPORATION's website URL: https://www.jcu-i.com/

Contact: Corporate Strategy Office

TEL: +81-3-6895-7004

